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June 19, 2006

TO: Commissioner for Patents

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Alexandria, VA 22313-1450

Fr: George O. Saile, Reg. No.19,572

Subject: Application No.

10/631,841

Confirmation No.:

1036

Applicant

Chun Shiah

Filed

July 31, 2004

Art Unit

2816

Examiner

Long T. Nguyen

Docket No.

ET01-010C

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APPEAL BRIEF

Dear Sir:

In response to the Final Rejection dated October 11, 2001 of Claims 1-42 under 35 USC §112, first and second paragraphs and under 35 USC §103(a) of the above reference patent application, please accept this appeal brief. The commissioner is hereby authorized to charge payment of \$250.00 associated with this communication to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to:

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on <u>62 | 106</u> (Date)

Stephen B. Ackorman, Reg. #37,74
Typed or printed name of person signing this certificate

Signature

Cea#3776 this certificate 06/26/2006 WABDELRI 00000005 190033

(i) Real Party in Interest:

An assignment has been recorded for this patent application. The assignee is:

Etron Technologies, Inc.

No. 6 Technology Road 5

Science-Based Industrial Park

Hsin-Chu, Taiwan 30077, R.O.C.

(ii) Related Appeals and Interferences:

There are no related appeals or interferences.

(iii) Status of Claims:

Claims 1-42 have been finally rejected under 35 U.S.C. § 112, first and second paragraphs and under 35 USC §103(a). No claims were allowed.

(iv) Status of Amendments:

Claims 1-42 have not been amended subsequent to Final Rejection. The Examiner states in the Final Rejection that the request for reconsideration of the amendment filed dated October 19, 2005 is still objected to 35 U.S.C. §132 because it introduces new matter into the disclosure of the invention and that claims 1-42 are rejected under 35 USC §112, first paragraph for failing to comply with the written description

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requirements; under 35 USC §112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which the applicant regards as the invention; and under 35 USC §103(a) as being unpatentable over in Applicant's Admitted Prior Art (AAPA) in view of U. S. Patent 6,373,328 (Rapp).

(v) Summary of the Invention:

Briefly, the applicants wish to point out the major features of their invention, which is a novel low jitter input buffer with small input signal swing. The low jitter input buffer includes a buffer input portion 101 of Fig. 2 and a buffer output portion 201 of Fig. 2. The buffer input portion 101 is constructed of the NMOS transistors N11 and N12 of Fig. 2 and PMOS transistors P11 and P12 of Fig. 2. The lower supply voltage VSS is applied to the source nodes of the NMOS transistors N11 and N12 of Fig. 2 and an upper supply voltage **VDD** is applied to the source nodes of the PMOS transistors P11 and P12 of Fig. 2. The gate nodes of transistors P11 and P12 and the drains of transistors N11 and P11 are connected together to form the biasing node **b11** of Fig. 2. The biasing voltage **VB11** is developed at the biasing node **b11** as a result of the configuration of transistors P11 and P12. A parasitic capacitor Cp of Fig. 2 is inherently coupled from the biasing node **b11** to the ground reference node. A reference supply voltage VREF is applied to the gate of transistor N11, input signal SIGNAL IN is applied to the gate of N12. A large capacitor

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CHC is attached between the bias node **b11** and the lower supply voltage **VSS**. The buffer output portion **201** of Fig. 2 includes a common node for the drain of NMOS transistor **N12** and the drain of PMOS transistor **P12**, which serves as input to inverter of Fig. 2. The output of inverter **I11** of Fig. 2 is the output signal **SIGNAL_OUT1** of Fig. 2.

The large capacitance CHC is in series with the parasitic capacitor Cp of the input buffer receiver transistors N11, P11, and P12. The large capacitor CHC, as connected, is designed to have an extremely large capacitance relative to the parasitic capacitor Cp such that the bias voltage VB11 essentially follows the voltage changes in the lower supply voltage VSS preventing the effects of the VSS noise. This coupling ratio is determined by the formula:

$$\frac{\mathsf{CHC}}{\mathsf{Cp} + \mathsf{CHC}} \approx 1$$

where:

CHC is the capacitance value of the large capacitor CHC.

Cp is the capacitance value of the parasitic capacitor Cp.

Because of its large coupling ratio (very close to 1), the capacitor

CHC essentially charge couples the biasing voltage VB11 at the bias node

b11, to the lower supply voltage VSS, of devices N11 and N12. This

forces the transistors N11 and N12 to activate and deactivate essentially simultaneously, allowing for a quicker response time on output signal SIGNAL_OUT1.

Claims 1, 12, 23, and 33 are read on the specification and drawings as follows:

1. An input buffer receiver comprising:

a buffer input portion (101 of Fig. 2; paragraph [0017], Line 2) for receiving an input signal (SIGNAL_IN of Fig. 2; paragraph [0017], Line 13), said buffer input portion (b1 of Fig. 2; paragraph [0017], Line 8) comprising a bias node (b1 of Fig. 2; paragraph [0017], Line 8);

a large capacitor (CHC of Fig. 2; paragraph [0017], Line 7) coupled between the bias node (b1 of Fig. 2; paragraph [0017], Line 8) and a lower supply voltage (VSS of Fig. 2; paragraph [0017], Line 10) for providing a coupling ratio between a capacitance value of said large capacitor (CHC of Fig. 2; paragraph [0017], Line 7) and a capacitance value of a parasitic capacitor (Cp of Fig. 2; paragraph [0017], Line 10) coupled between said bias node (b1 of Fig. 2; paragraph [0017], Line 8) and a ground reference point is approximately equal to a unity value such that a biasing

17		voltage (VD11 in paragraph [UU17], Line o) at said blasing
18		node (b1 of Fig. 2; paragraph [0017], Line 8) follows said
19		lower supply voltage (VSS of Fig. 2; paragraph [0017], Line
20		10) to minimize effects of a ground noise signal between the
21		lower supply voltage (VSS of Fig. 2; paragraph [0017], Line
22		10) and the ground reference point; and
23		a buffer output portion (201 of Fig. 2; paragraph [0017], Line 2)
24		in communication with the buffer input portion (101 of Fig. 2;
25		paragraph [0017], Line 2) for producing an output signal
26		(SIGNAL_OUT1 of Fig. 2; paragraph [0017], Line 17).
1	12.	An integrated circuit formed on a substrate comprising:
2		an input buffer receiver for receiving an input signal, said
3		input buffer comprising:
4		a buffer input portion (101 of Fig. 2; paragraph [0017],
5		Line 2) for receiving an input signal SIGNAL_IN of
6		Fig. 2; paragraph [0017], Line 13), said buffer
7		input portion (101 of Fig. 2; paragraph [0017], Line
8		2) comprising a bias node (b1 of Fig. 2; paragraph

10	a large capacitor (CHC of Fig. 2; paragraph [0017],
1-1	Line 7) coupled between the bias node (b1 of Fig.
12	2; paragraph [0017], Line 8) and a lower supply
13	voltage (VSS of Fig. 2; paragraph [0017], Line 10)
14	for providing a coupling ratio between a
15	capacitance value of said large capacitor (CHC of
. 16	Fig. 2; paragraph [0017], Line 7) and a
17	capacitance value of a parasitic capacitor (Cp of
18	Fig. 2; paragraph [0017], Line 10) coupled
19	between said bias node (b1 of Fig. 2; paragraph
20	[0017], Line 8) and a ground reference point is
21	approximately equal to a unity value such that a
22	biasing voltage (Vb11 in paragraph [0017], Line 8)
23	at said biasing node (b1 of Fig. 2; paragraph
24	[0017], Line 8) follows said lower supply voltage
25	(VSS of Fig. 2; paragraph [0017], Line 10) to
26	minimize effects of a ground noise signal between
27	the lower supply voltage (VSS of Fig. 2; paragraph
28	[0017], Line 10) and the ground reference point;
29	and
-	a hoffen autout martin (OOA of Ein Oomen)
30	a buffer output portion (201 of Fig. 2; paragraph
31	[0017], Line 2) in communication with the buffer

32		input portion (201 of Fig. 2; paragraph [0017], Line
33	*	2) for producing an output signal(SIGNAL_OUT1
34		of Fig. 2; paragraph [0017], Line 17).
1	23.	A method for minimizing effects of ground noise on an input buffer
2		receiver comprising the steps of:
3		forming a buffer input portion (101 of Fig. 2; paragraph
4		[0017], Line 2) for receiving an input signal SIGNAL_IN
5		of Fig. 2; paragraph [0017], Line 13) on a substrate;
6		forming a bias node (b1 of Fig. 2; paragraph [0017], Line 8)
7		within said buffer input portion (101 of Fig. 2; paragraph
8		[0017], Line 2);
9		connecting a lower supply voltage (VSS of Fig. 2; paragraph
10		[0017], Line 10) to said buffer input portion (101 of Fig. 2;
11		paragraph [0017], Line 2);
12		forming a large capacitor (CHC of Fig. 2; paragraph [0017],
13		Line 7) coupled between the bias node and the lower
14		supply voltage (VSS of Fig. 2; paragraph [0017], Line 10)
15		for providing a coupling ratio between a capacitance
16		value of said large capacitor (CHC of Fig. 2; paragraph
17		[0017], Line 7) and a capacitance value of a parasitic

18	capacitor (Cp of Fig. 2; paragraph [0017], Line 10)
19	coupled between said bias node (b1 of Fig. 2; paragraph
20	[0017], Line 8) and a ground reference point is
21	approximately equal to a unity value such that a biasing
22	voltage at said biasing node (b1 of Fig. 2; paragraph
23	[0017], Line 8) follows said lower supply voltage (VSS of
24	Fig. 2; paragraph [0017], Line 10) to minimize effects of
25	said ground noise between the lower supply voltage
26	(VSS of Fig. 2; paragraph [0017], Line 10) and the
27	ground reference point; and
28	forming a buffer output portion (201 of Fig. 2; paragraph
29	[0017], Line 2) on said substrate in communication with
30	the buffer input portion (101 of Fig. 2; paragraph [0017],
31	Line 2) for producing an output signal.
1	33. An apparatus for minimizing effects of ground noise within an input
2	buffer receiver, said apparatus comprising:
3	means for forming a buffer input portion (101 of Fig. 2;
3	means for forming a sunct input portion (101 of 1ig. 2,
4	paragraph [0017], Line 2) for receiving an input signal
5	SIGNAL_IN of Fig. 2; paragraph [0017], Line 13) on a
6	substrate;

7	means for forming a bias node (b1 of Fig. 2; paragraph
8	[0017], Line 8) within said buffer input portion (101 of Fig.
9	2; paragraph [0017], Line 2);
10	means for connecting a lower supply voltage (VSS of Fig. 2;
I 1	paragraph [0017], Line 10) to said buffer input portion
12	(101 of Fig. 2; paragraph [0017], Line 2);
13	means for forming a large capacitor (CHC of Fig. 2;
14	paragraph [0017], Line 7) between the bias node (b1 of
15	Fig. 2; paragraph [0017], Line 8) and the lower supply
16	voltage (VSS of Fig. 2; paragraph [0017], Line 10) for
17	providing a coupling ratio between a capacitance value of
18	said large capacitor (CHC of Fig. 2; paragraph [0017],
19	Line 7) and a capacitance value of a parasitic capacitor
20	(Cp of Fig. 2; paragraph [0017], Line 10) coupled
21	between said bias node (b1 of Fig. 2; paragraph [0017],
22	Line 8) and a ground reference point is approximately
23	equal to a unity value such that a biasing voltage (Vb11
24	in paragraph [0017], Line 8) at said biasing node (b1 of
25	Fig. 2; paragraph [0017], Line 8) follows said lower
26	supply voltage (VSS of Fig. 2) to minimize effects of said

27	ground noise between the lower supply voltage (VSS of
28	Fig. 2) and the ground reference point; and
29	means for forming a buffer output portion (201 of Fig. 2;
30	paragraph [0017], Line 2) on said substrate in
31	communication with the buffer input portion (101 of Fig.
32	2; paragraph [0017], Line 2)for producing an output
33	signal.

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(vi) Grounds of rejection to be reviewed on appeal:

The issues of this appeal are whether:

 The amendment filed 1/14/05 should be objected to under 35 U.S.C. §132 because it introduces new matter into the disclosure of the invention;

- Claims 1-42 are unpatentable under 35 USC §112, first paragraph for failing to comply with the written description requirements; and
- 3) Claims 1-42 are unpatentable under 35 USC §103(a) of Claims 1-42 over in Applicant's Admitted Prior Art (AAPA) in view of U. S. Patent 6,373,328 (Rapp)

(vii) Argument:

Reconsideration of the objection to the amendment filed 1/14/05 under 35 U.S.C. §132 because it introduces new matter into the disclosure of the invention. The applicant believes that added material is not new matter. The original text describes that:

"Because of its large coupling ratio, CHC essentially charge couples the VB11 gate voltage of the PMOS bias node, to the VSS source voltage..." (Page 5, last paragraph, lines 2-4)

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Employing basic electronic principles, the large coupling ratio provides a charge coupling or AC coupling of the biasing voltage VB11 at the bias node b11 to the lower supply voltage VSS. Thus the coupling ratio would be defined as:

$$CR = \frac{VB11}{VSS} = \frac{VSS \frac{Z_{CP}}{Z_{HC} + Z_{CP}}}{VSS} = \frac{Z_{CP}}{Z_{HC} + Z_{CP}}$$
$$= \frac{\frac{1}{j\omega C_P}}{\frac{1}{j\omega C_{HC}} + \frac{1}{J\omega C_{HC}}} = \frac{C_{HC}}{C_{HC} + C_P}$$

Where:

$$\mathbf{Z}_{\mathsf{CP}} = \frac{1}{j\omega \mathbf{C}_{\mathsf{P}}},$$

$$Z_{HC} = \frac{1}{J_{\omega}C_{HC}}$$
, and

$$VB11 = V_{CP} = VSS \frac{Z_{CP}}{Z_{HC} + Z_{CP}}.$$

It can be shown that as the magnitude of the capacitance of the large capacitor C_{HC} relative to the capacitance of the parasitic capacitor C_{P} grows larger, any noise voltage present on the lower supply voltage VSS is charge coupled or AC coupled directly to the bias node **b11**. Further it is apparent that the larger magnitude of the capacitance of the large

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capacitor C_{HC} relative to the capacitance of the parasitic capacitor C_P, the coupling ratio approaches a maximum value of unity (1), therefore a large coupling value would clearly be any value that approached unity (1).

Reconsideration of the rejection under 35 USC §112, first paragraph of Claims 1-42 for failing to comply with the written description requirements, in that the claims contain subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor at the time of the application was filed, had possession of the claimed invention is requested in light of the following arguments.

The original text describes that:

"Because of its large coupling ratio, CHC essentially charge couples the VB11 gate voltage of the PMOS bias node, to the VSS source voltage..." (Page 5, last paragraph, lines 2-4)

Employing basic electronic principles, the large coupling ratio provides a charge coupling or AC coupling of the biasing voltage VB11 at the bias node b11 to the lower supply voltage VSS. Thus the coupling ratio would be defined:

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$$CR = \frac{VB11}{VSS} = \frac{VSS \frac{Z_{CP}}{Z_{HC} + Z_{CP}}}{VSS} = \frac{Z_{CP}}{Z_{HC} + Z_{CP}}$$
$$= \frac{\frac{1}{j\omega C_P}}{\frac{1}{j\omega C_{HC}} + \frac{1}{j\omega C_{HC}}} = \frac{C_{HC}}{C_{HC} + C_P}$$

Where:

$$\label{eq:ZCP} Z_{\text{CP}} = \frac{1}{j \, \omega C_{\text{P}}} \mbox{ is the impedance of the parasitic}$$
 capacitance $C_{\text{P}}.$

 $Z_{HC} = \frac{1}{j\omega C_{HC}}$ is the impedance of the very large capacitance C_{HC} .

VB11 =
$$V_{CP} = VSS \frac{Z_{CP}}{Z_{HC} + Z_{CP}}$$
 is the voltage

VB11 present at the node b11 and can be found as a voltage divider of the impedance Z_{HC} of the very large capacitor C_{HC} and the impedance Z_{CP} of the parasitic capacitor C_P as shown.

It can be shown that as the magnitude of the capacitance of the large capacitor C_{HC} relative to the capacitance of the parasitic capacitor C_P grows larger, any noise voltage present on the lower supply voltage VSS

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is charge coupled or AC coupled directly to the bias node b11. Further it is apparent that the larger magnitude of the capacitance of the large capacitor C_{HC} relative to the capacitance of the parasitic capacitor C_P, the coupling ratio approaches a maximum value of unity (1), therefore a large coupling value would clearly be any value that approached unity (1).

The concept of coupling ratio is not new in the art, as shown in Silicon Processing for the VLSI Era, Volume II Process Integration, Wolf, Latice Press, Sunset Beach, CA., 1990, pp. 623-627. In nonvolatile or Flash memory, the capacitive coupling coefficient of the capacitance of the control gate to the floating gate of the nonvolatile memory cell and the capacitance of the floating gate of the nonvolatile memory cells to the bulk semiconductor substrate of a nonvolatile memory cell, the coupling coefficient is used to determine the amount of charge coupled to the floating gate to determine the necessary programming voltages and the time for programming the nonvolatile memory cell. The serial structure of the floating gate nonvolatile memory employs similar concepts to the present invention. The very large capacitor C_{HC} in series with the parasitic capacitor C_P as shown in Fig. 4a demonstrates that the large value of capacitance of the very large capacitor C_{HC} relative to the parasitic capacitor C_P causes the voltage VB11 at the node b11 is essentially equal to the lower supply voltage VSS and the coupling ratio approaches one (1) as shown above.

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Reconsideration of the rejection under 35 USC §112, second paragraph, of Claims 1-42 as being indefinite for failing to particularly point out and distinctly claim the subject matter which the applicant regards as the invention is requested in light of the following arguments.

In Claims 1, 12, 23, and 33, a large capacitor is coupled between the bias node and the lower supply voltage:

"for providing a coupling ratio between a capacitance value of said large capacitor and a capacitance value of a parasitic capacitor coupled between said bias node and a ground reference point is approximately equal to a unity value such that a biasing voltage at said biasing node follows said lower supply voltage to minimize effects of said ground noise between the lower supply voltage and the ground reference point."

As shown in <u>Silicon Processing for the VLSI Era, Volume II Process</u>

<u>Integration</u>, Wolf, Latice Press, Sunset Beach, CA., 1990, pp: 623-627, the coupling ratio is not the ratio of the value of capacitance between the very large capacitor C_{HC} and parasitic capacitor C_P (C_{HC}/C_P), but the AC coupling of the biasing voltage VB11 at the bias node b11 to the lower supply voltage VSS. This is essentially a capacitive voltage divider and as

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shown above, the voltage VB11 at the bias node b11 become a function of the coupling ratio ($\frac{C_{HC}}{C_{HC}+C_P}$).

Reconsideration of the rejection under 35 USC §103(a) of Claims 1-42 as being unpatentable over in Applicant's Admitted Prior Art (AAPA) in view of U. S. Patent 6,373,328 (Rapp) is requested in light of the following arguments.

The AAPA does illustrate an input buffer receiver and Rapp does show "an n-type transistor 90" connected to serve "as a capacitor, helping to hold the voltage constant at the gate of transistor 86" (Rapp, Col 9, Lines 38-42). Neither AAPA, nor Rapp, nor AAPA in combination with Rapp include:

a large capacitor between the bias node and the lower supply voltage for providing a coupling ratio between a capacitance value of said large capacitor and a capacitance value of a parasitic capacitor coupled between said bias node and a ground reference point is approximately equal to a unity value such that a biasing voltage at said biasing node follows said lower supply voltage to minimize effects of said ground noise between the lower supply voltage and the ground reference point; (Claim 1, Lines 4-11 and Claim 12, Lines 7-17)

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forming a large capacitor between the bias node and the lower supply voltage for providing a coupling ratio between a capacitance value of said large capacitor and a capacitance value of a parasitic capacitor coupled between said bias node and a ground reference point is approximately equal to a unity value such that a biasing voltage at said biasing node follows said lower supply voltage to minimize effects of said ground noise between the lower supply voltage and the ground reference point; (Claim 23, Lines 6-13)

and

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means for forming a large capacitor between the bias node and the lower supply voltage for providing a coupling ratio between a capacitance value of said large capacitor and a capacitance value of a parasitic capacitor coupled between said bias node and a ground reference point is approximately equal to a unity value such that a biasing voltage at said biasing node follows said lower supply voltage to minimize effects of said ground noise between the lower supply voltage and the ground reference point. (Claim 33, Lines 8-15)

The large capacitor in Rapp is connected to the ground reference point and does not charge couple the biasing node to the lower supply voltage such that the voltage at the biasing node follows the lower supply

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voltage. Further, the circuit of Rapp provides a comparator circuit that compares the voltage value of a programming voltage supply V_{PP} at node A of Fig. 5 of Rapp against the voltage value of the power supply voltage V_{DD} . The capacitor of Rapp helps "to hold the voltage constant at the gate of transistor 86" this does not provide the coupling of the lower supply voltage to the biasing node of this invention.

The invention as claimed in amended Claims 1-42 is believed to be novel and patentable over AAPA in view of Rapp because there is not sufficient basis for concluding that claimed elements of either AAPA, or Rapp, or AAPA in combination with Rapp would have been obvious to one skilled in the art. That is to say, there must be something in the prior art or line of reasoning to suggest that the combination of these various references is desirable. The applicant believes that there is no such basis for the combination.

(viii) Claims appendix.

Listing of Claims:

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1. An input buffer receiver comprising:

a buffer input portion for receiving an input signal, said buffer input portion comprising a bias node;

a large capacitor coupled between the bias node and a lower supply voltage for providing a coupling ratio between a capacitance value of said large capacitor and a capacitance value of a parasitic capacitor coupled between said bias node and a ground reference point is approximately equal to a unity value such that a biasing voltage at said biasing node follows said lower supply voltage to minimize effects of a ground noise signal between the lower supply voltage and the ground reference point; and

a buffer output portion in communication with the buffer input portion for producing an output signal.

2. The input buffer receiver of claim 1, wherein the buffer input portion which receives the input signal further comprises:

3		a first transistor of a first conductivity type having a source node
4		to which the lower supply voltage is applied, a gate node to
5		which a reference voltage is applied, and a drain node at
6		which the biasing voltage is developed;
7		a second transistor of a second conductivity type having a drain
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8		node which is connected to the drain node of the first
9		transistor, and a gate node at which the biasing voltage is
0		developed, and a source node to which an upper supply
1		voltage source is applied;
2		a third transistor of the second conductivity type having a drain
2		a third transistor of the second conductivity type having a drain
13		node, a gate node at which the biasing voltage is developed,
4		and a source node to which the upper supply voltage source
5		is applied;
6		a fourth transistor of the first conductivity type having a source
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7		node to which the lower supply voltage is applied, a gate
8		node to which the input signal is applied, and a drain node
9		which is coupled to the drain of a fourth transistor and to an
20		input node of the buffer output portion.
1	3.	The input buffer receiver of claim 2, wherein the first and fourth
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transistors are PMOS transistors.

transistors are NMOS transistors, and the second and third

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- 4. The input buffer receiver of claim 2, wherein the large capacitor is connected between the sources of the first and fourth transistors of the buffer input portion and the gate of the second transistor of the buffer input portion.
- The input buffer receiver of claim 2, wherein the gate of the second transistor is connected to its drain.
- 6. The input buffer receiver of claim 2, wherein the gate of the second transistor is connected to the drain of the first transistor.
 - 7. The input buffer receiver of claim 2, wherein the gate of the second transistor is connected to the gate of the third transistor.
 - 8. The input buffer receiver of claim 2, wherein the buffer output portion which produces the output signal comprises: a first inverter connected to the drain of the third transistor and the drain of the fourth transistor.
- 9. The input buffer receiver of claim 2, wherein the third transistor and the fourth transistor activate and deactivate almost simultaneously as determined by said input signal to minimize the effects of ground noise on a delay jitter factor of said input buffer.
 - 10. The input buffer receiver of claim 1, wherein the large capacitor charge couples the bias node of the input buffer receiver to the

lower supply voltage of the input buffer receiver and wherein a capacitance value of the large capacitor is selected by the formula:

$$\frac{\text{CHC}}{\text{Cp + CHC}} \approx 1$$

6 where:

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7 CHC is the capacitance value of the large capacitor,
8 and

Cp is the capacitance value of the parasitic capacitor.

- 11. The input buffer receiver of claim 1, wherein the capacitance value of the large capacitor is chosen to be very large with respect to said capacitance value of said parasitic capacitor and results in a quicker response time for the output signal.
- 12. An integrated circuit formed on a substrate comprising:
- an input buffer receiver for receiving an input signal, said input

 buffer comprising:
 - a buffer input portion for receiving the input signal, said buffer input portion comprising a bias node;
 - a large capacitor coupled between the bias node and a lower supply voltage for providing a coupling

8		ratio between a capacitance value said large
9		capacitor and a capacitance value of a parasitic
10		capacitor coupled between said bias node and a
11		ground reference point is approximately equal to a
12		unity value such that a biasing voltage at said
13		biasing node follows said lower supply voltage to
14		minimize effects of a ground noise signal between
15		the lower supply voltage and the ground reference
16		point ; and
17		a buffer output portion in communication with the
18		buffer input portion for producing an output signal.
1	13.	The integrated circuit of claim 12, wherein the buffer input portion of
2		the input buffer receiver further comprises:
3		a first transistor of a first conductivity type having a source node
4		to which the lower supply voltage is applied, a gate node to
5		which a reference voltage is applied, and a drain node at
6		which the biasing voltage is developed;
7		a second transistor of a second conductivity type having a drain
8		node which is connected to the drain node of the first

transistor, and a gate node at which the biasing voltage is

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developed, and a source node to which an upper supply 10 voltage source is applied; 11 a third transistor of the second conductivity type having a drain 12 node, a gate node at which the biasing voltage is developed. 13 and a source node to which the upper supply voltage source 14 is applied; 15 a fourth transistor of the first conductivity type having a source 16 node to which the lower supply voltage is applied, a gate 17 node to which an input signal is applied, and a drain node 18 which is connected to the drain of a fourth transistor and to 19 an input node of the buffer output portion. 20 14. The integrated circuit of claim 13, wherein the first and fourth 1 transistors are NMOS transistors, and the second and third 2 transistors are PMOS transistors. 3

- 15. The integrated circuit of claim 13, wherein the large capacitor is connected between the sources of the first and fourth transistors of the buffer input portion and the gate of the second transistor of the buffer input portion.
- 16. The integrated circuit of claim 13, wherein the gate of the second transistor is connected to its drain.

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- 17. The integrated circuit of claim 13, wherein the gate of the second transistor is connected to the drain of the first transistor.
 - 18. The integrated circuit of claim 13, wherein the gate of the second transistor is connected to the gate of the third transistor.
 - 19. The integrated circuit of claim 13, wherein the buffer output portion which produces said output signal comprises: a first inverter connected to the drain of the third transistor and the drain of the fourth transistor.
 - 20. The integrated circuit of claim 13, wherein the third transistor and the fourth transistor activate and deactivate almost simultaneously as determined by said input signal to minimize the effects of ground noise on a delay jitter factor of said input buffer.
 - 21. The integrated circuit of claim 12, wherein the large capacitor charge couples the bias node of the input buffer receiver to the lower supply voltage of the input buffer receiver and wherein a capacitance value of the large capacitor is selected by the formula:

$$\frac{\text{CHC}}{\text{Cp+CHC}} \approx 7$$

where:

CHC is the capacitance value of the large capacitor. 7 and 8 **Cp** is the capacitance value of the parasitic capacitor. 9 22. The integrated circuit of claim 12, wherein the capacitance value of 1 the large capacitor is chosen to be very large with respect to said 2 capacitance value of said parasitic capacitor and results in a 3 quicker response time for the output signal. 4 23. A method for minimizing effects of ground noise on an input buffer 1 receiver comprising the steps of: 2 forming a buffer input portion for receiving an input signal on a 3 substrate; 4 forming a bias node within said buffer input portion; 5 connecting a lower supply voltage to said buffer input portion; 6 forming a large capacitor coupled between the bias node and 7 the lower supply voltage for providing a coupling ratio 8 between a capacitance value of said large capacitor and a 9 capacitance value of a parasitic capacitor coupled between 10 said bias node and a ground reference point is 11 approximately equal to a unity value such that a biasing 12 voltage at said biasing node follows said lower supply 13

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voltage to minimize effects of said ground noise between the 14 lower supply voltage and the ground reference point; and 15 forming a buffer output portion on said substrate in 16 communication with the buffer input portion for producing an 17 output signal. 18 24. The method of claim 23, wherein forming the buffer input portion 1 further comprises the steps of: 2 forming a first transistor of a first conductivity type on said 3 substrate; applying the lower supply voltage to a source node of the first 5 transistor: 6 applying a reference voltage to a gate node of the first 7 transistor; 8 connecting a drain node of the first transistor to develop a 9 biasing voltage at said drain node; 10 forming a second transistor of a second conductivity type on 11 said substrate; 12 connecting a drain node of the second transistor to the drain 13 node of the first transistor; 14

15	connecting a gate node of the second transistor to the drain
16	node of the first transistor for developing the biasing voltage:
17	and
18	connecting a source node of the second transistor to an upper
19	supply voltage;
20	forming a third transistor of the second conductivity type on said
21	substrate;
22	connecting a gate node of the third transistor to the drain node
23	of the first transistor for developing the biasing voltage;
24	connecting a source node of the third transistor to the upper
25	supply voltage source;
26	forming a fourth transistor of the first conductivity type on said
27	substrate;
28	connecting a source node of the fourth transistor to the lower
29	supply voltage;
30	connecting a gate node of the fourth transistor to receive an
31	input signal; and

32		connecting a drain node of the fourth translator to a drain node
33		of the third transistor and to an input node of the buffer
34		output portion.
1	25.	The method of claim 24, wherein the first and fourth transistors are
2		NMOS transistors, and the second and third transistors are PMOS
3		transistors.
1	26.	The method of claim 24, wherein forming the large capacitor
2		comprises the step of:
3		connecting said large capacitor between the sources of the first
4		and fourth transistors of the buffer input portion and the gate
5		of the second transistor of the buffer input portion.
1	27.	The method of claim 24, wherein forming the buffer input portion
2		further comprises the steps of:
3		connecting the gate of the second transistor to its drain.
1	28.	The method of claim 24, wherein forming the buffer input portion
2		further comprises the steps of:
3		connecting the gate of the second transistor to the gate of the
4		third transistor.

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29. The method of claim 24, wherein forming the buffer output portion which produces the output signal comprises the step of:

forming a first inverter on said substrate; and

- connecting an input of said first inverter to the drain of the third transistor and the drain of the fourth transistor.
- 30. The method of claim 24, wherein the third transistor and the fourth transistor activate and deactivate almost simultaneously as determined by said input signal to minimize the effects of ground noise on a delay jitter factor of said input buffer.
- 31. The method of claim 23, wherein the large capacitor charge couples the bias node of the input buffer receiver to the lower supply voltage of the input buffer receiver and wherein a capacitance value of the large capacitor is selected by the formula:

$$\frac{\text{CHC}}{\text{Cp+CHC}} \approx 1$$

where:

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7 CHC is the capacitance value of the large capacitor,
8 and

Cp is the capacitance value of the parasitic capacitor.

The method of claim 23, wherein the capacitance value of the large capacitor is chosen to be very large with respect to said capacitance value of said parasitic capacitor and results in a quicker response time for the output signal.

An apparatus for minimizing effects of ground noise within an input

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- 33. An apparatus for minimizing effects of ground noise within an input buffer receiver, said apparatus comprising:
 - means for forming a buffer input portion for receiving an input signal on a substrate;
 - means for forming a bias node within said buffer input portion;

 means for connecting a lower supply voltage to said buffer input portion;

means for forming a large capacitor between the bias node and the lower supply voltage for providing a coupling ratio between a capacitance value of said large capacitor and a capacitance value of a parasitic capacitor coupled between said bias node and a ground reference point is approximately equal to a unity value such that a biasing voltage at said biasing node follows said lower supply voltage to minimize effects of said ground noise between the lower supply voltage and the ground reference point; and

17		means for forming a buffer output portion on said substrate in
18		communication with the buffer input portion for producing an
19		output signal.
1	34.	The apparatus of claim 33, wherein forming the buffer input portion
2	٠	further comprises:
3	٠	means for forming a first transistor of a first conductivity type on
4		said substrate;
5		means for applying the lower supply voltage to a source node of
6		the first transistor;
7		means for applying a reference voltage to a gate node of the
8		first transistor;
9		means for connecting a drain node of the first transistor to
10		develop as biasing voltage at said drain node;
11		means for forming a second transistor of a second conductivity
12		type on said substrate;
13		means for connecting a drain node of the second transistor to
14		the drain node of the first transistor;

15	means for connecting a gate flode of the second transistor to
16	the drain node of the first transistor for developing the
17	biasing voltage; and
18	means for connecting a source node of the second transistor to
19	an upper supply voltage;
20	means for forming a third transistor of the second conductivity
21	type on said substrate;
22	means for connecting a gate node of the third transistor to the
23	drain node of the first transistor for developing the biasing
24	voltage;
25	means for connecting a source node of the third transistor to the
26	upper supply voltage source;
27	means for forming a fourth transistor of the first conductivity type
28	on said substrate;
29	means for connecting a source node of the fourth transistor to
30	the lower supply voltage;
31	means for connecting a gate node of the fourth transistor to
32	receive said input signal; and

	connecting a drain node of the fourth transistor to a drain node
	of the third transistor and to an input of the buffer output
	portion.
35.	The apparatus of claim 34, wherein the first and fourth transistors
	are NMOS transistors, and the second and third transistors are
	PMOS transistors.
36.	The apparatus of claim 34, wherein means for forming the large
	capacitor comprises:
	means for connecting said large capacitor between the sources
	of the first and fourth transistors of the buffer input portion
	and the gate of the second transistor of the buffer input
	portion.
37.	The apparatus of claim 34, wherein means for forming the buffer
	input portion further comprises:
	means for connecting the gate of the second transistor to its
	drain.
38.	The apparatus of claim 34, wherein means for forming the buffer
	input portion further comprises the steps of:
	means for connecting the gate of the second transistor to the
	gate of the third transistor.
	36. 37.

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39. The apparatus of claim 34, wherein means for forming the buffer output portion which produces said output signal comprises:

means for forming a first inverter on said substrate; and

means for connecting an input of said first inverter to the drain of the third transistor and the drain of the fourth transistor.

- 40. The apparatus of claim 34, wherein the third transistor and the fourth transistor activate and deactivate almost simultaneously as determined by said input signal to minimize the effects of ground noise on a delay jitter factor of said input buffer.
- 41. The apparatus of claim 33, wherein the large capacitor charge couples the bias node of the input buffer receiver to the lower supply voltage of the input buffer receiver and wherein a capacitance value of the large capacitor is selected by the formula:

$$\frac{\text{CHC}}{\text{Cp+CHC}} \approx 1$$

where:

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7 CHC is the capacitance value of the large capacitor CHC, and

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9 **Cp** is the capacitance value of the parasitic capacitor **Cp**.

42. The apparatus of claim 33, wherein the capacitance value of the large capacitor is chosen to be very large with respect to said capacitance value of said parasitic capacitor and results in a quicker response time for the output signal.

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(ix) Evidence appendix.

There is no evidence submitted pursuant to 37 CFR §§ 1.130, 1.131, or 1.132 or any other.

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(x) Related proceedings appendix.

There are no related appeals or interferences.

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The applicants request that the Board of Appeals reverse the holding of the examiner in finally rejecting the Claims of the application. Allowance of all Claims is requested.

Respectfully Submitted, George O. Saile & Associates

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